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Intel - EPF10K50SQC208-3 Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	360
Number of Logic Elements/Cells	2880
Total RAM Bits	40960
Number of I/O	147
Number of Gates	199000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf10k50sqc208-3

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Table 2. FLEX 10KE Device Features			
Feature	EPF10K100E (2)	EPF10K130E	EPF10K200E EPF10K200S
Typical gates (1)	100,000	130,000	200,000
Maximum system gates	257,000	342,000	513,000
Logic elements (LEs)	4,992	6,656	9,984
EABs	12	16	24
Total RAM bits	49,152	65,536	98,304
Maximum user I/O pins	338	413	470

Note to tables:

- (1) The embedded IEEE Std. 1149.1 JTAG circuitry adds up to 31,250 gates in addition to the listed typical or maximum system gates.
- (2) New EPF10K100B designs should use EPF10K100E devices.

...and More

- Fabricated on an advanced process and operate with a 2.5-V internal supply voltage
- In-circuit reconfigurability (ICR) via external configuration devices, intelligent controller, or JTAG port
- ClockLock[™] and ClockBoost[™] options for reduced clock _ delay/skew and clock multiplication
- Built-in low-skew clock distribution trees
- 100% functional testing of all devices; test vectors or scan chains are not required
- Pull-up on I/O pins before and during configuration
- Flexible interconnect
 - FastTrack[®] Interconnect continuous routing structure for fast, predictable interconnect delays
 - Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
 - Dedicated cascade chain that implements high-speed, high-fan-in logic functions (automatically used by software tools and megafunctions)
 - Tri-state emulation that implements internal tri-state buses
 - Up to six global clock signals and four global clear signals
 - Powerful I/O pins
 - Individual tri-state output enable control for each pin
 - Open-drain option on each I/O pin
 - Programmable output slew-rate control to reduce switching noise
 - Clamp to V_{CCIO} user-selectable on a pin-by-pin basis
 - Supports hot-socketing



Figure 4. FLEX 10KE Device in Single-Port RAM Mode

Note:

(1) EPF10K30E, EPF10K50E, and EPF10K50S devices have 88 EAB local interconnect channels; EPF10K100E, EPF10K130E, EPF10K200E, and EPF10K200S devices have 104 EAB local interconnect channels.

EABs can be used to implement synchronous RAM, which is easier to use than asynchronous RAM. A circuit using asynchronous RAM must generate the RAM write enable signal, while ensuring that its data and address signals meet setup and hold time specifications relative to the write enable signal. In contrast, the EAB's synchronous RAM generates its own write enable signal and is self-timed with respect to the input or write clock. A circuit using the EAB's self-timed RAM must only meet the setup and hold time specifications of the global clock.

Figure 7. FLEX 10KE LAB



Notes:

- (1) EPF10K30E, EPF10K50E, and EPF10K50S devices have 22 inputs to the LAB local interconnect channel from the row; EPF10K100E, EPF10K130E, EPF10K200E, and EPF10K200S devices have 26.
- (2) EPF10K30E, EPF10K50E, and EPF10K50S devices have 30 LAB local interconnect channels; EPF10K100E, EPF10K130E, EPF10K200E, and EPF10K200S devices have 34.

LE Operating Modes

The FLEX 10KE LE can operate in the following four modes:

- Normal mode
- Arithmetic mode
- Up/down counter mode
- Clearable counter mode

Each of these modes uses LE resources differently. In each mode, seven available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. Three inputs to the LE provide clock, clear, and preset control for the register. The Altera software, in conjunction with parameterized functions such as LPM and DesignWare functions, automatically chooses the appropriate mode for common functions such as counters, adders, and multipliers. If required, the designer can also create special-purpose functions that use a specific LE operating mode for optimal performance.

The architecture provides a synchronous clock enable to the register in all four modes. The Altera software can set DATA1 to enable the register synchronously, providing easy implementation of fully synchronous designs.



Figure 11. FLEX 10KE LE Operating Modes









Clearable Counter Mode



In addition to the six clear and preset modes, FLEX 10KE devices provide a chip-wide reset pin that can reset all registers in the device. Use of this feature is set during design entry. In any of the clear and preset modes, the chip-wide reset overrides all other signals. Registers with asynchronous presets may be preset when the chip-wide reset is asserted. Inversion can be used to implement the asynchronous preset. Figure 12 shows examples of how to setup the preset and clear inputs for the desired functionality.



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Asynchronous Clear

The flipflop can be cleared by either LABCTRL1 or LABCTRL2. In this mode, the preset signal is tied to VCC to deactivate it.

Asynchronous Preset

An asynchronous preset is implemented as an asynchronous load, or with an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a one into the register. Alternatively, the Altera software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

Asynchronous Preset & Clear

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. DATA3 is tied to VCC, so that asserting LABCTRL1 asynchronously loads a one into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

Asynchronous Load with Clear

When implementing an asynchronous load in conjunction with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear; LABCTRL2 does not have to feed the preset circuits.

Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with preset, the Altera software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 presets the register, while asserting LABCTRL1 loads the register. The Altera software inverts the signal that drives DATA3 to account for the inversion of the register's output.

Asynchronous Load without Preset or Clear

When implementing an asynchronous load without preset or clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

For improved routing, the row interconnect consists of a combination of full-length and half-length channels. The full-length channels connect to all LABs in a row; the half-length channels connect to the LABs in half of the row. The EAB can be driven by the half-length channels in the left half of the row and by the full-length channels. The EAB drives out to the fulllength channels. In addition to providing a predictable, row-wide interconnect, this architecture provides increased routing resources. Two neighboring LABs can be connected using a half-row channel, thereby saving the other half of the channel for the other half of the row.

Table 7 summarizes the FastTrack Interconnect routing structure resources available in each FLEX 10KE device.

Table 7. FLEX 1	OKE FastTra	ck Interconnect Re	sources	
Device	Rows	Channels per Row	Columns	Channels per Column
EPF10K30E	6	216	36	24
EPF10K50E EPF10K50S	10	216	36	24
EPF10K100E	12	312	52	24
EPF10K130E	16	312	52	32
EPF10K200E EPF10K200S	24	312	52	48

In addition to general-purpose I/O pins, FLEX 10KE devices have six dedicated input pins that provide low-skew signal distribution across the device. These six inputs can be used for global clock, clear, preset, and peripheral output enable and clock enable control signals. These signals are available as control signals for all LABs and IOEs in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Figure 14 shows the interconnection of adjacent LABs and EABs, with row, column, and local interconnects, as well as the associated cascade and carry chains. Each LAB is labeled according to its location: a letter represents the row and a number represents the column. For example, LAB B3 is in row B, column 3.

ClockLock & ClockBoost Features

To support high-speed designs, FLEX 10KE devices offer optional ClockLock and ClockBoost circuitry containing a phase-locked loop (PLL) used to increase design speed and reduce resource usage. The ClockLock circuitry uses a synchronizing PLL that reduces the clock delay and skew within a device. This reduction minimizes clock-to-output and setup times while maintaining zero hold times. The ClockBoost circuitry, which provides a clock multiplier, allows the designer to enhance device area efficiency by resource sharing within the device. The ClockBoost feature allows the designer to distribute a low-speed clock and multiply that clock on-device. Combined, the ClockLock and ClockBoost features provide significant improvements in system performance and bandwidth.

All FLEX 10KE devices, except EPF10K50E and EPF10K200E devices, support ClockLock and ClockBoost circuitry. EPF10K50S and EPF10K200S devices support this circuitry. Devices that support Clock-Lock and ClockBoost circuitry are distinguished with an "X" suffix in the ordering code; for instance, the EPF10K200SFC672-1X device supports this circuit.

The ClockLock and ClockBoost features in FLEX 10KE devices are enabled through the Altera software. External devices are not required to use these features. The output of the ClockLock and ClockBoost circuits is not available at any of the device pins.

The ClockLock and ClockBoost circuitry locks onto the rising edge of the incoming clock. The circuit output can drive the clock inputs of registers only; the generated clock cannot be gated or inverted.

The dedicated clock pin (GCLK1) supplies the clock to the ClockLock and ClockBoost circuitry. When the dedicated clock pin is driving the ClockLock or ClockBoost circuitry, it cannot drive elsewhere in the device.

For designs that require both a multiplied and non-multiplied clock, the clock trace on the board can be connected to the GCLK1 pin. In the Altera software, the GCLK1 pin can feed both the ClockLock and ClockBoost circuitry in the FLEX 10KE device. However, when both circuits are used, the other clock pin cannot be used.

The VCCINT pins must always be connected to a 2.5-V power supply. With a 2.5-V V_{CCINT} level, input voltages are compatible with 2.5-V, 3.3-V, and 5.0-V inputs. The VCCIO pins can be connected to either a 2.5-V or 3.3-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with V_{CCIO} levels higher than 3.0 V achieve a faster timing delay of t_{OD2} instead of t_{OD1} .

Table 14. FLEX 10	KE Multi	/olt I/O Su	pport			
V _{CCIO} (V)	In	put Signal	(V)	Out	out Signal	(V)
	2.5	3.3	5.0	2.5	3.3	5.0
2.5	\checkmark	✓(1)	✓(1)	 		
3.3	~	\checkmark	✓(1)	√ (2)	\checkmark	~

Table 14 summarizes FLEX 10KE MultiVolt I/O support.

Notes:

(1) The PCI clamping diode must be disabled to drive an input with voltages higher than $V_{\rm CCIO}$.

(2) When V_{CCIO} = 3.3 V, a FLEX 10KE device can drive a 2.5-V device that has 3.3-V tolerant inputs.

Open-drain output pins on FLEX 10KE devices (with a pull-up resistor to the 5.0-V supply) can drive 5.0-V CMOS input pins that require a $V_{\rm IH}$ of 3.5 V. When the open-drain pin is active, it will drive low. When the pin is inactive, the trace will be pulled up to 5.0 V by the resistor. The open-drain pin will only drive low or tri-state; it will never drive high. The rise time is dependent on the value of the pull-up resistor and load impedance. The I_{OL} current specification should be considered when selecting a pull-up resistor.

Power Sequencing & Hot-Socketing

Because FLEX 10KE devices can be used in a mixed-voltage environment, they have been designed specifically to tolerate any possible power-up sequence. The $V_{\rm CCIO}$ and $V_{\rm CCINT}$ power planes can be powered in any order.

Signals can be driven into FLEX 10KE devices before and during power up without damaging the device. Additionally, FLEX 10KE devices do not drive out during power up. Once operating conditions are reached, FLEX 10KE devices operate as specified by the user. Figure 22 shows the required relationship between V_{CCIO} and V_{CCINT} for 3.3-V PCI compliance.



Figure 23 shows the typical output drive characteristics of FLEX 10KE devices with 3.3-V and 2.5-V V_{CCIO}. The output driver is compliant to the 3.3-V *PCI Local Bus Specification*, *Revision 2.2* (when VCCIO pins are connected to 3.3 V). FLEX 10KE devices with a -1 speed grade also comply with the drive strength requirements of the *PCI Local Bus Specification*, *Revision 2.2* (when VCCINT pins are powered with a minimum supply of 2.375 V, and VCCIO pins are connected to 3.3 V). Therefore, these devices can be used in open 5.0-V PCI systems.

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Figure 26. FLEX 10KE Device IOE Timing Model

Figure 27. FLEX 10KE Device EAB Timing Model



Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{CGENR}		0.1		0.1		0.2	ns
t _{CASC}		0.6		0.8		1.0	ns
t _C		0.0		0.0		0.0	ns
t _{CO}		0.3		0.4		0.5	ns
t _{COMB}		0.4		0.4		0.6	ns
t _{SU}	0.4		0.6		0.6		ns
t _H	0.7		1.0		1.3		ns
t _{PRE}		0.8		0.9		1.2	ns
t _{CLR}		0.8		0.9		1.2	ns
t _{CH}	2.0		2.5		2.5		ns
t _{CL}	2.0		2.5		2.5		ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{IOD}		2.4		2.8		3.8	ns
t _{IOC}		0.3		0.4		0.5	ns
t _{IOCO}		1.0		1.1		1.6	ns
t _{IOCOMB}		0.0		0.0		0.0	ns
t _{IOSU}	1.2		1.4		1.9		ns
t _{IOH}	0.3		0.4		0.5		ns
t _{IOCLR}		1.0		1.1		1.6	ns
t _{OD1}		1.9		2.3		3.0	ns
t _{OD2}		1.4		1.8		2.5	ns
t _{OD3}		4.4		5.2		7.0	ns
t _{XZ}		2.7		3.1		4.3	ns
t _{ZX1}		2.7		3.1		4.3	ns
t _{ZX2}		2.2		2.6		3.8	ns
t _{ZX3}		5.2		6.0		8.3	ns
t _{INREG}		3.4		4.1		5.5	ns
t _{IOFD}		0.8		1.3		2.4	ns
t _{INCOMB}		0.8		1.3		2.4	ns

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Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	d Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{EABAA}		6.4		7.6		8.8	ns
t _{EABRCOMB}	6.4		7.6		8.8		ns
t _{EABRCREG}	4.4		5.1		6.0		ns
t _{EABWP}	2.5		2.9		3.3		ns
t _{EABWCOMB}	6.0		7.0		8.0		ns
t _{EABWCREG}	6.8		7.8		9.0		ns
t _{EABDD}		5.7		6.7		7.7	ns
t _{EABDATACO}		0.8		0.9		1.1	ns
t _{EABDATASU}	1.5		1.7		2.0		ns
t _{EABDATAH}	0.0		0.0		0.0		ns
t _{EABWESU}	1.3		1.4		1.7		ns
t _{EABWEH}	0.0		0.0		0.0		ns
t _{EABWDSU}	1.5		1.7		2.0		ns
t _{EABWDH}	0.0		0.0		0.0		ns
t _{EABWASU}	3.0		3.6		4.3		ns
t _{EABWAH}	0.5		0.5		0.4		ns
t _{EABWO}		5.1		6.0		6.8	ns

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Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{EABDATA1}		1.7		2.0		2.7	ns
t _{EABDATA1}		0.6		0.7		0.9	ns
t _{EABWE1}		1.1		1.3		1.8	ns
t _{EABWE2}		0.4		0.4		0.6	ns
t _{EABRE1}		0.8		0.9		1.2	ns
t _{EABRE2}		0.4		0.4		0.6	ns
t _{EABCLK}		0.0		0.0		0.0	ns
t _{EABCO}		0.3		0.3		0.5	ns
t _{EABBYPASS}		0.5		0.6		0.8	ns
t _{EABSU}	0.9		1.0		1.4		ns
t _{EABH}	0.4		0.4		0.6		ns
t _{EABCLR}	0.3		0.3		0.5		ns
t _{AA}		3.2		3.8		5.1	ns
t _{WP}	2.5		2.9		3.9		ns
t _{RP}	0.9		1.1		1.5		ns
t _{WDSU}	0.9		1.0		1.4		ns
t _{WDH}	0.1		0.1		0.2		ns
t _{WASU}	1.7		2.0		2.7		ns
t _{WAH}	1.8		2.1		2.9		ns
t _{RASU}	3.1		3.7		5.0		ns
t _{RAH}	0.2		0.2		0.3		ns
t _{WO}		2.5		2.9		3.9	ns
t _{DD}		2.5		2.9		3.9	ns
t _{EABOUT}		0.5		0.6		0.8	ns
t _{EABCH}	1.5		2.0		2.5		ns
t _{EABCL}	2.5		2.9		3.9		ns

Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Мах	
t _{EABWCOMB}	6.7		8.1		10.7		ns
t _{EABWCREG}	6.6		8.0		10.6		ns
t _{EABDD}		4.0		5.1		6.7	ns
t _{EABDATACO}		0.8		1.0		1.3	ns
t _{EABDATASU}	1.3		1.6		2.1		ns
t _{EABDATAH}	0.0		0.0		0.0		ns
t _{EABWESU}	0.9		1.1		1.5		ns
t _{EABWEH}	0.4		0.5		0.6		ns
t _{EABWDSU}	1.5		1.8		2.4		ns
t _{EABWDH}	0.0		0.0		0.0		ns
t _{EABWASU}	3.0		3.6		4.7		ns
t _{EABWAH}	0.4		0.5		0.7		ns
t _{EABWO}		3.4		4.4		5.8	ns

 Table 63. EPF10K200E Device Interconnect Timing Microparameters
 Note (1)

Symbol	-1 Spee	ed Grade	-2 Spee	d Grade	-3 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{DIN2IOE}		4.2		4.6		5.7	ns
t _{DIN2LE}		1.7		1.7		2.0	ns
t _{DIN2DATA}		1.9		2.1		3.0	ns
t _{DCLK2IOE}		2.5		2.9		4.0	ns
t _{DCLK2LE}		1.7		1.7		2.0	ns
t _{SAMELAB}		0.1		0.1		0.2	ns
t _{SAMEROW}		2.3		2.6		3.6	ns
t _{SAMECOLUMN}		2.5		2.7		4.1	ns
t _{DIFFROW}		4.8		5.3		7.7	ns
t _{TWOROWS}		7.1		7.9		11.3	ns
t _{LEPERIPH}		7.0		7.6		9.0	ns
t _{LABCARRY}		0.1		0.1		0.2	ns
t _{LABCASC}		0.9		1.0		1.4	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	
t _{EABDATA1}		1.7		2.4		3.2	ns
t _{EABDATA2}		0.4		0.6		0.8	ns
t _{EABWE1}		1.0		1.4		1.9	ns
t _{EABWE2}		0.0		0.0		0.0	ns
t _{EABRE1}		0.0		0.0		0.0	
t _{EABRE2}		0.4		0.6		0.8	
t _{EABCLK}		0.0		0.0		0.0	ns
t _{EABCO}		0.8		1.1		1.5	ns
t _{EABBYPASS}		0.0		0.0		0.0	ns
t _{EABSU}	0.7		1.0		1.3		ns
t _{EABH}	0.4		0.6		0.8		ns
t _{EABCLR}	0.8		1.1		1.5		
t _{AA}		2.0		2.8		3.8	ns
t _{WP}	2.0		2.8		3.8		ns
t _{RP}	1.0		1.4		1.9		
t _{WDSU}	0.5		0.7		0.9		ns
t _{WDH}	0.1		0.1		0.2		ns
t _{WASU}	1.0		1.4		1.9		ns
t _{WAH}	1.5		2.1		2.9		ns
t _{RASU}	1.5		2.1		2.8		
t _{RAH}	0.1		0.1		0.2		
t _{WO}		2.1		2.9		4.0	ns
t _{DD}		2.1		2.9		4.0	ns
t _{EABOUT}		0.0		0.0		0.0	ns
t _{EABCH}	1.5		2.0		2.5		ns
t _{EABCL}	1.5		2.0		2.5	İ	ns

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Table 74. EPF10k	K200S Device	e IOE Timing	g Microparaı	neters (Par	t 2 of 2)	Note (1)	
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{ZX2}		4.5		4.8		6.6	ns
t _{ZX3}		6.6		7.6		10.1	ns
t _{INREG}		3.7		5.7		7.7	ns
t _{IOFD}		1.8		3.4		4.0	ns
t _{INCOMB}		1.8		3.4		4.0	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{EABDATA1}		1.8		2.4		3.2	ns
t _{EABDATA1}		0.4		0.5		0.6	ns
t _{EABWE1}		1.1		1.7		2.3	ns
t _{EABWE2}		0.0		0.0		0.0	ns
t _{EABRE1}		0		0		0	ns
t _{EABRE2}		0.4		0.5		0.6	ns
t _{EABCLK}		0.0		0.0		0.0	ns
t _{EABCO}		0.8		0.9		1.2	ns
t _{EABBYPASS}		0.0		0.1		0.1	ns
t _{EABSU}	0.7		1.1		1.5		ns
t _{EABH}	0.4		0.5		0.6		ns
t _{EABCLR}	0.8		0.9		1.2		ns
t _{AA}		2.1		3.7		4.9	ns
t _{WP}	2.1		4.0		5.3		ns
t _{RP}	1.1		1.1		1.5		ns
t _{WDSU}	0.5		1.1		1.5		ns
t _{WDH}	0.1		0.1		0.1		ns
twasu	1.1		1.6		2.1		ns
t _{WAH}	1.6		2.5		3.3		ns
t _{RASU}	1.6		2.6		3.5		ns
t _{RAH}	0.1		0.1		0.2		ns
t _{WO}		2.0		2.4		3.2	ns
t _{DD}		2.0		2.4		3.2	ns
t _{EABOUT}		0.0		0.1		0.1	ns
t _{EABCH}	1.5		2.0		2.5		ns
t _{EABCL}	2.1		2.8		3.8		ns

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Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{EABAA}		3.9		6.4		8.4	ns
t _{EABRCOMB}	3.9		6.4		8.4		ns
t _{EABRCREG}	3.6		5.7		7.6		ns
t _{EABWP}	2.1		4.0		5.3		ns
t _{EABWCOMB}	4.8		8.1		10.7		ns
t _{EABWCREG}	5.4		8.0		10.6		ns
t _{EABDD}		3.8		5.1		6.7	ns
t _{EABDATACO}		0.8		1.0		1.3	ns
t _{EABDATASU}	1.1		1.6		2.1		ns
t _{EABDATAH}	0.0		0.0		0.0		ns
t _{EABWESU}	0.7		1.1		1.5		ns
t _{EABWEH}	0.4		0.5		0.6		ns
t _{EABWDSU}	1.2		1.8		2.4		ns
t _{EABWDH}	0.0		0.0		0.0		ns
t _{EABWASU}	1.9		3.6		4.7		ns
t _{EABWAH}	0.8		0.5		0.7		ns
t _{EABWO}		3.1		4.4		5.8	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Мах	Min	Мах	Min	Max	
t _{DIN2IOE}		4.4		4.8		5.5	ns
t _{DIN2LE}		0.6		0.6		0.9	ns
t _{DIN2DATA}		1.8		2.1		2.8	ns
t _{DCLK2IOE}		1.7		2.0		2.8	ns
t _{DCLK2LE}		0.6		0.6		0.9	ns
t _{SAMELAB}		0.1		0.1		0.2	ns
t _{SAMEROW}		3.0		4.6		5.7	ns
t _{SAME} COLUMN		3.5		4.9		6.4	ns
t _{DIFFROW}		6.5		9.5		12.1	ns
t _{TWOROWS}		9.5		14.1		17.8	ns
t _{LEPERIPH}		5.5		6.2		7.2	ns
t _{LABCARRY}		0.3		0.1		0.2	ns

Additionally, the Altera software offers several features that help plan for future device migration by preventing the use of conflicting I/O pins.

Table 81. I/O Counts for FLEX 10KA & FLEX 10KE Devices						
FLEX 10	KA	FLEX 10KE				
Device	I/O Count	Device	I/O Count			
EPF10K30AF256	191	EPF10K30EF256	176			
EPF10K30AF484	246	EPF10K30EF484	220			
EPF10K50VB356	274	EPF10K50SB356	220			
EPF10K50VF484	291	EPF10K50EF484	254			
EPF10K50VF484	291	EPF10K50SF484	254			
EPF10K100AF484	369	EPF10K100EF484	338			

Configuration Schemes

The configuration data for a FLEX 10KE device can be loaded with one of five configuration schemes (see Table 82), chosen on the basis of the target application. An EPC1, EPC2, or EPC16 configuration device, intelligent controller, or the JTAG port can be used to control the configuration of a FLEX 10KE device, allowing automatic configuration on system power-up.

Multiple FLEX 10KE devices can be configured in any of the five configuration schemes by connecting the configuration enable (nCE) and configuration enable output (nCEO) pins on each device. Additional FLEX 10K, FLEX 10KA, FLEX 10KE, and FLEX 6000 devices can be configured in the same serial chain.

Table 82. Data Sources for FLEX 10KE Configuration					
Configuration Scheme	Data Source				
Configuration device	EPC1, EPC2, or EPC16 configuration device				
Passive serial (PS)	BitBlaster, ByteBlasterMV, or MasterBlaster download cables, or serial data source				
Passive parallel asynchronous (PPA)	Parallel data source				
Passive parallel synchronous (PPS)	Parallel data source				
JTAG	BitBlaster or ByteBlasterMV download cables, or microprocessor with a Jam STAPL file or JBC file				